STATEMENT OF PURPOSE:

The Lansing Black Lawyers Association has established its annual scholarship awards. The purpose of the awards are to encourage African American students with community ties to remain and practice in the Lansing area, and also to recognize achievement in the study of the law.

AWARD:

We currently offer two scholarships, the Judge John W. Davis, Jr. Scholarship and the Stuart J. Dunnings, Jr. Scholarship.

(1) The amount of the awards shall not exceed $1,000.00;
(2) The awards will be presented to the recipients at the Lansing Black Lawyers Associations Annual Otis Smith Scholarship Banquet to be held March 12, 2010 at 6:00 p.m. at the Lansing Country Club;

ELIGIBILITY:

(1) African American students attending the Thomas M. Cooley Law School or MSU College of Law;
(2) who have achieved upper class status at their respective law school (completed in excess of 24 credit hours);
(3) who are enrolled in a degree program (either full or part-time),
(4) and who are enrolled at the time of the award.

SELECTION CRITERIA:

Selection shall be based on academic achievement and community service. In addition, the selection committee may give consideration to financial need and career objectives.

APPLICATION PROCESS:

(1) A completed application shall be submitted and received by the LBLA on or before February 12, 2010. The applicant shall include a transcript of his or her grades with his or her application.
(2) Interviews will be held on Saturday **February 20, 2010 between 9:00 am and 3:00 p.m.** All interview scheduling and notification will be by e-mail.

(3) Scholarship winners will be asked to provide a short statement for the Scholarship Banquet souvenir book by **February 27, 2010**.

The completed application and transcript can be submitted by mail to:

**Lansing Black Lawyers Association**  
**Scholarship Committee**  
**P.O. Box 18222**  
**Lansing, MI 48901**

Applications can also be submitted by e-mail to **lansingblacklawyers@msn.com**. Please be sure to place Scholarship Application in the subject line and attach or mail in your transcript.

Please direct any questions to Dawn C. M. Jack at (517) 322-1246 or jackd@michigan.gov or Shenique Moss at mosss@michigan.gov.
1. NAME:_______________________________________________________________________________
   (Last)          (First)                 (Middle)

2. TELEPHONE: _________________________________________

3. PERMANENT ADDRESS: _________________________________________________________________

4. LOCAL ADDRESS: __________________________________________________ _____________________

5. E-MAIL ADDRESS: ________________________________________________________________

6. UNDERGRADUATE INSTITUTION:_________________________________________________________
   (a) Major/Degree(s) earned: ______________________________________________  GPA:  ____________

7. LAW SCHOOL:  _______________________________________________________  GPA:  ____________
   (a) Previous law school enrollment? (Yes or No) _________
   (b) If yes, where _____________________________________________________ GPA:  _____________

8. LIST COMMUNITY SERVICE AND LAW SCHOOL ACTIVITIES. (Use additional sheet(s) if necessary.)
   (a) Community Service:_________________________________________________________________
       ________________________________________________________________ _______________________

   (b) Law School:  ______________________________________________________________________
       ___________________________________________________________________________________
       ___________________________________________________________________________________
       ___________________________________________________________________________________

9. HONORS AND AWARDS:_________________________________________________________________
   ____________________________________________________________________________________
   ____________________________________________________________________________________
   ____________________________________________________________________________________

10. If I become a recipient of an LBLA Scholarship Award, I agree to attend the Awards Banquet on
    March 12, 2010.
    Yes: ______ No: ______ If No: Please explain: ____________________________________________
11. CAREER PLANS:

Provide a brief statement of your career objectives after graduation from law school. (The selection committee will consider the form and clarity of your statement.) (Use additional sheet(s) if necessary.)

_____________________________________________________________________________________________
_____________________________________________________________________________________________
_____________________________________________________________________________________________
_____________________________________________________________________________________________

12. FINANCIAL INFORMATION:

<table>
<thead>
<tr>
<th>Estimated Costs</th>
<th>Annual/Monthly</th>
<th>Estimated Resources</th>
<th>Annual/Monthly</th>
</tr>
</thead>
<tbody>
<tr>
<td>Tuition - Fees</td>
<td>$</td>
<td>Scholarship/Grants</td>
<td>$</td>
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<tr>
<td>Room and Board</td>
<td></td>
<td>Government Assistance</td>
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<tr>
<td>Books/Supplies</td>
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<td>Student Loans</td>
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<td>Transportation</td>
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<td>Earnings</td>
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<td>Savings</td>
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<td>Parental/Spousal Assistance</td>
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<td>Other (Itemize):</td>
<td></td>
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</tbody>
</table>

13. INTERVIEW AVAILABILITY

I am available for interview on February 20, 2010 at the following times (please mark at least 2):

___ 9:00 a.m. - 10:00 a.m.     ___ 10:00 a.m. - 11:00 a.m.     ___ 11:00 a.m. - 12:00 p.m.
___ 12:00 p.m. - 1:00 p.m.    ___ 1:00 p.m. - 2:00 p.m.    ___ 2:00 p.m. - 3:00 p.m.

I declare to the best of my knowledge that the information contained in this application is true, accurate and complete.

_________________________     _______________________
Date                     Signature